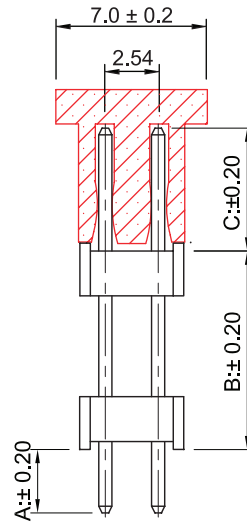
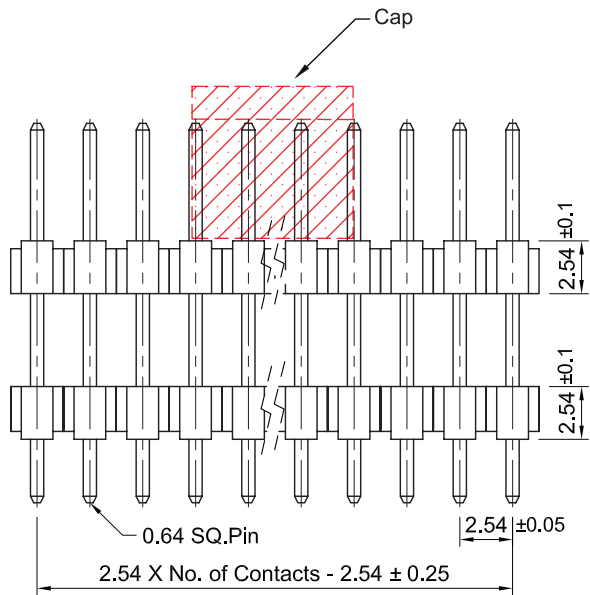
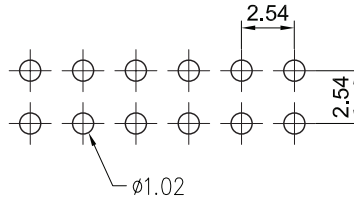


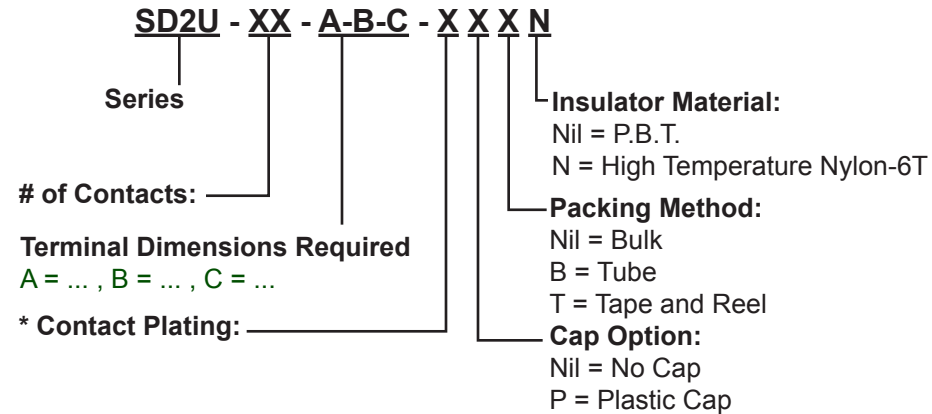
Recommended P.C. Board Hole Layout



Specifications

- Current Rating: 3 Amps
- Insulator Resistance: 1000 Megohms min.
- Contact Resistance: 20 m ohms max.
- Dielectric Withstanding: AC 600V
- Operating Temperature: P.B.T.: -40°C ~ +105°C
Nylon-6T: -40°C ~ +125°C
- Contact Material: Brass
- Insulator Material: Polyester, UL94V-0 P.B.T., or Nylon-6T
- Contact Plated: See options
Standard: Fildd Gold Flash

Part Numbering System



*** 10 Pins (2x5) Example: SD2U-10-3.00-5.08-6.00-GPBN**
A = 3.00mm, B = 5.08mm, C = 6.00mm

* Contact Plating Option	Full Gold Plating	Gold Plated On Contact Area Tin Plated on Solder Area	Full Tin Plating
	G : Gold Flash G10: Gold 10u" G15: Gold 15u" G30: Gold 30u"	S: Gold Flash S10: Gold 10u" S15: Gold 15u" S30: Gold 30u"	T: Tin 100u"

General Tolerance	
X. ± 0.50	X.° ± 5°
.X ± 0.20	.X' ± 2°
.XX ± 0.10	.XX° ± 1°
Units : mm	